

# June 2007 Ultrafast Rectifier

# FFD10UP20S

#### **Features**

- Ultrafast with soft recovery, trr < 35ns
- Reverse Voltage, 200V
- Forward Voltage < 1.1V @  $T_C$  100°C
- · RoHS compliant

#### **Applications**

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply







1. Cathode 2. Anode

# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
$V_{RRM}$	Peak Repetitive Reverse Voltage	200	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 115°C	10	Α	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current  60Hz Single Half-Sine Wave	100	А	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-65 to +150	°C	

#### **Thermal Characteristics**

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.0	°C/W

# **Package Marking and Ordering Information**

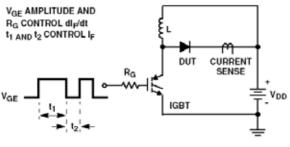
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F10UP20S	FFD10UP20S	TO-252	13" Dia	-	2500

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

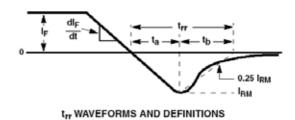
Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage $I_F = 10A$ $I_F = 10A$	$T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$			1.15 1.10	V
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 100^{\rm o}{\rm C}$		-	100 500	μА
t <sub>rr</sub> I <sub>rr</sub> Q <sub>rr</sub>	Reverse Recovery Time Reverse Recovery Current Reverse Recovery Charge (I <sub>F</sub> = 10A, di/dt = 200A/µs)		20.8 2.8 28.5	- - -	ns A nC	
t <sub>rr</sub>	Maximum Reverse Recovery Time $(I_F = 1A, di/dt = 100A/\mu s)$		-	-	35	ns
W <sub>AVL</sub>	Avalanche Energy ( L = 40mH)		10	-	-	mJ

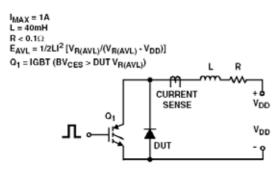
<sup>\*</sup> Pulse Test: Pulse Width = 300μs, Duty Cycle = 2%

# **Test Circuit and Waveforms**

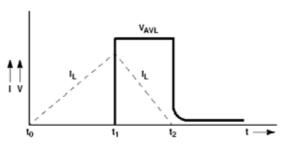


t<sub>rr</sub> TEST CIRCUIT





AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

# **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop vs. Forward Current

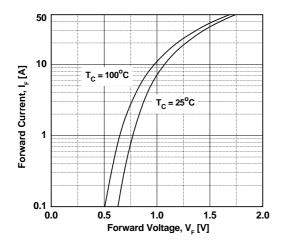


Figure 3. Typical Junction Capacitance

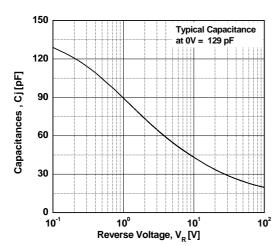


Figure 5. Typical Reverse Recovery

Current vs. di/dt

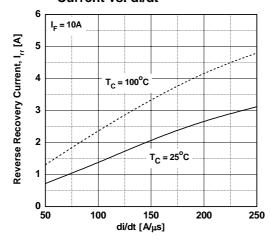


Figure 2. Typical Reverse Current vs. Reverse Voltage

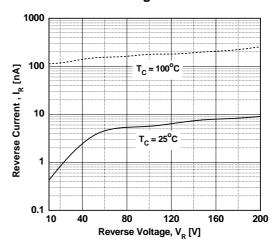
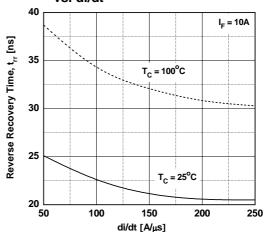
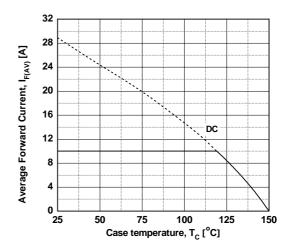


Figure 4. Typical Reverse Recovery Time vs. di/dt

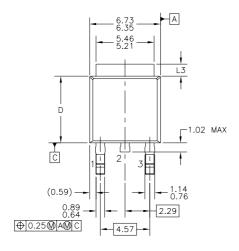


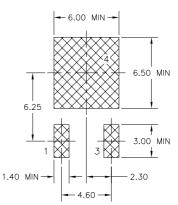
**Figure 6. Forward Current Derating Curve** 

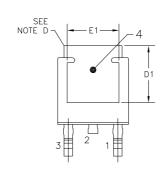


# **Mechanical Dimensions**

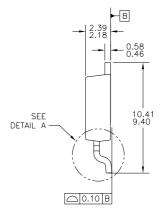
# **D-PAK**

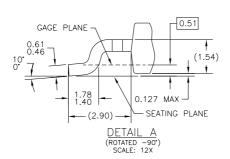












- NOTES: UNLESS OTHERWISE SPECIFIED

  A) ALL DIMENSIONS ARE IN MILLIMETERS.

  B) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C, VARIATION AA & AB, DATED NOV. 1999.

  C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

  D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.

  E) DIMENSIONS L3,D,E1&D1 TABLE:

  [OPTION AN TOPTION AB]

	OPTION AA	OPTION AB
L3	0.89-1.27	1.52-2.03
D	5.97-6.22	5.33-5.59
E1	4.32 MIN	3.81 MIN
D1	5.21 MIN	4.57 MIN

PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL.

Dimensions in Millimeters





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CROSSVOLT™	IntelliMAX™	QFET <sup>®</sup>	TinyBoost™
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FRFET <sup>®</sup>	Power220 <sup>®</sup>	SuperSOT™-3	UniFET™
Global Power Resourse <sup>SM</sup>	Power247 <sup>®</sup>	SuperSOT™-6	VCX <sup>TM</sup>
Green FPS™	POEWEREDGE <sup>®</sup>	SuperSOT™-8	

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#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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·		This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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